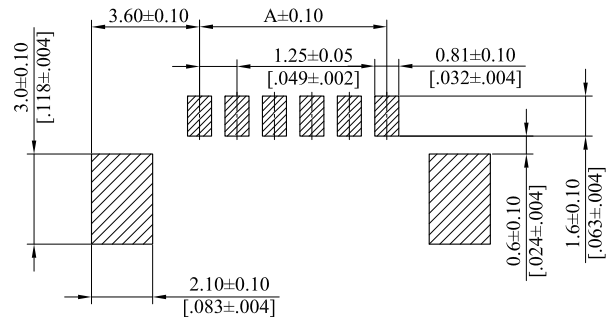
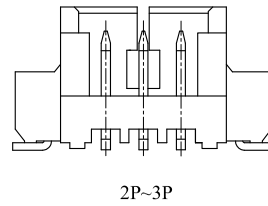
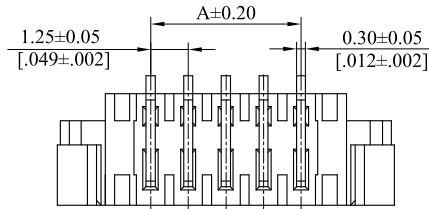
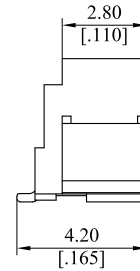
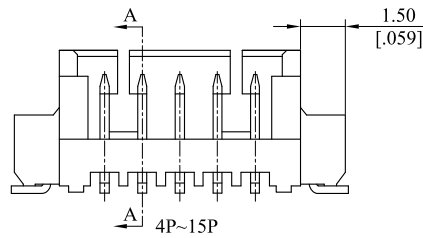
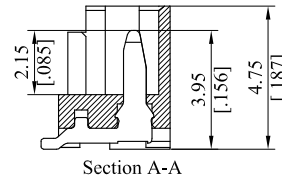
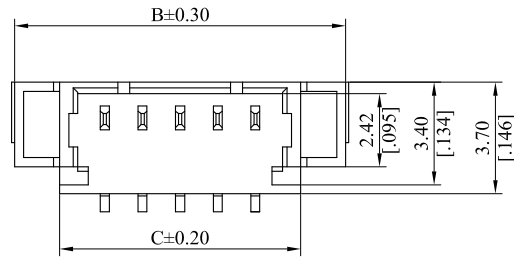


RoHS COMPLIANT

CUSTOMER DRAWING

REV.	ECO. NO.	DESCRIPTION	DATE
F	ES170822	UPDATE	2017.08.18



Recommended PCB Layout

Note:

Material:

Insulator: High Temperature Thermoplastic, UL94 V-0, Natural

Contact: Copper Alloy

Solder Tabs: Brass

Specification:

Current Rating: 1A AC,DC

Voltage Rating: 125V AC,DC

Temperature Rating: -40°C~+105°C;

General Part Number:

1254P ** M V * 0
1 2

1. No. of circuits(02~15)

2. Plating:

0=Matte Tin plated 80μ"min. over 30μ"min. Nickel underplating overall
F=Selective Gold flash on contact area over 30μ"min. Nickel underplating overall, Tin plated on solder tails

J= 15μ"min. Selective Gold on contact area over 30μ"min. Nickel underplating overall, Tin plated on solder tails

K=30μ"min. Selective Gold on contact area over 30μ"min. Nickel underplating overall, Tin plated on solder tails

A=1.25mm(.049")*No. of spaces

B=A+6.00mm(.236")

C=A+3.00mm(.118")

TOLERANCE UNLESS OTHERWISE SPECIFIED			LEOCO CORPORATION http://www.leoco.com.tw		
mm [inch]	mm	inch	APPROVED BY:	DATE:	TITLE:
1 PLACE	± 0.30	± ---	Chard	2017.08.18	1.25mm(.049") Pitch Straight Type SMT Wafer
2 PLACES	± 0.20	± .012	CHECKED BY:	DATE:	
3 PLACES	± 0.10	± .008	Angel	2017.08.18	PART NO.: 1254P**MV*0
4 PLACES	± ---	± .004	Brian	2017.08.18	
ANGULAR ±1°			SIZE: A3	SCALE: 1:1	DRAWING NO.: 125406S
					REV.: F
					SHEET: 1 OF 1